

 $\mathbf{\Omega}$ 

⋖

Ш

 $\mathbf{\alpha}$ 

Σο

Ш

Z

ш

ш

C

ш

SEPT 2013 REV. 1.0.0

#### GENERAL DESCRIPTION

The XR3070-78X family of high performance RS-485/
 422 devices are designed for improved performance in noisy industrial environments and increased tolerance to system faults.

The analog bus pins can withstand direct shorts up to ±18V, and are protected against ESD events up to ±15kV. The differential high output driver delivers 10% higher SNR than standard RS-485/422 devices, affording additional noise margin or extended cable lengths.

The receivers include full fail-safe circuitry, guaranteeing a logic-high receiver output when the receiver inputs are open, shorted, or undriven. The receiver input impedance is at minimum  $96k\Omega$  (1/8 unit load), allowing up to 256 devices on the bus while preserving the full signal margin.

The drivers are protected by short circuit detection as well as thermal shutdown, and maintain high impedance in shutdown or when powered off. The XR3070-75X drivers are slew limited for reduced EMI and error-free communication over long or unterminated data cables.

The devices with DE and  $\overline{RE}$  pins include hot swap circuitry to prevent false transitions on the bus during powerup or live insertion, and can enter a 1nA low current shutdown mode for extreme power savings.

The transceivers draw less than  $600\mu\text{A}$  from a +3.3V supply, and typically only  $300\mu\text{A}$  when idling with the receivers active.

8 V<sub>CC</sub>

7 B

6 A

5 GND

#### **FEATURES**

- 10% Higher SNR (Signal-to-Noise Ratio) compared to other RS-485 devices (1.65V vs. 1.5V)
- ±18V Fault Tolerance on Analog Bus pins
- Robust ESD (ElectroStatic Discharge) Protection:
  - ±15kV IEC 61000-4-2 Air Gap Discharge
  - ±8kV IEC 61000-4-2 Contact Discharge
  - ±15kV Human Body Model
  - ± 4kV Human Body Model on non-bus pins
- +3.0V to +3.6V Operation (3.3V ± 10%)
- 300µA Idle Current, 1nA Shutdown Current
- Enhanced Receiver Fail-Safe Protection for Open, Shorted, or Terminated but Idle Data Lines
- Hot-Swap Glitch Protection on DE and RE Pins
- Driver Short Circuit Current Limit and Thermal Shutdown for Overload Protection
- 1/8<sup>th</sup> Unit Load Allows up to 256 Devices on Bus
- Industry Standard 8 and 14 NSOIC Packages

# S RO 1 RE 2 DE 3 DI 4 U

#### TYPICAL APPLICATIONS

- Motor Control
- Security Systems
- Building and Process Automation
- Remote Utility Meter Reading
- Energy Monitoring and Control
- Long or Unterminated Transmission Lines

ഗ

#### **ABSOLUTE MAXIMUM RATINGS**

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections to the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability and cause permanent damage to the device.

| V <sub>CC</sub>   | -0.3V to +7.0V                        |
|---|---------------------------------------|
| Input Voltage at Control and Driver Input (RE, DE, and DI)  | -0.3V to +7.0V                        |
| Receiver Output Voltage (RO)  | -0.3V to (V <sub>CC</sub> + 0.3V)     |
| Driver Output Voltage (A, B, Y and Z)   | ±18V                                  |
| Receiver Input Voltage (A and B, half or full duplex)   | ±18V                                  |
| Transient Voltage Pulse, through 100 $\Omega$   | ±70V                                  |
| Driver Output Current   | ±250mA                                |
| Storage Temperature Range   | -65°C to +150°C                       |
| Lead Temperature (soldering, 10s)   | +300°C                                |
| Package Power Dissipation<br>8-Pin SO $\Theta_{JA} = 128.4^{\circ}\text{C/W}$<br>14-Pin SO $\Theta_{JA} = 86^{\circ}\text{C/W}$ | Maximum Junction Temperature = +150°C |

#### CAUTION:

ESD (Electrostatic Discharge) sensitive device. Permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. Personnel should be properly grounded prior to handling this device. The protective foam should be discharged to the destination socket before devices are removed.

#### ORDERING INFORMATION

| PART NUMBER | DUPLEX | DATA RATE | PACKAGE            | TEMPERATURE RANGE |
|-------------|--------|-----------|--------------------|-------------------|
| XR3070XID-F | Full   | 250kbps   | 14-pin Narrow SOIC | -40°C to +85°C    |
| XR3071XID-F | Full   | 250kbps   | 8-pin Narrow SOIC  | -40°C to +85°C    |
| XR3072XID-F | Half   | 250kbps   | 8-pin Narrow SOIC  | -40°C to +85°C    |
| XR3073XID-F | Full   | 1Mbps     | 14-pin Narrow SOIC | -40°C to +85°C    |
| XR3074XID-F | Full   | 1Mbps     | 8-pin Narrow SOIC  | -40°C to +85°C    |
| XR3075XID-F | Half   | 1Mbps     | 8-pin Narrow SOIC  | -40°C to +85°C    |
| XR3076XID-F | Full   | 20Mbps    | 14-pin Narrow SOIC | -40°C to +85°C    |
| XR3077XID-F | Full   | 20Mbps    | 8-pin Narrow SOIC  | -40°C to +85°C    |
| XR3078XID-F | Half   | 20Mbps    | 8-pin Narrow SOIC  | -40°C to +85°C    |

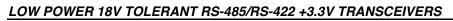
**Note:** Tape and Reel part numbers are XR30xxXIDTR-F, -F = Green / RoHS Compliant



# **ELECTRICAL CHARACTERISTICS**

| SYMBOL            | PARAMETERS  | Min. | TYP.               | Max.            | Units | Conditions  |  |  |  |
|-------------------|---|------|--------------------|-----------------|-------|---|--|--|--|
| DRIVER DC         | DRIVER DC CHARACTERISTICS                           |      |                    |                 |       |   |  |  |  |
| V <sub>CC</sub>   | Supply Voltage Range                                | 3.0  |                    | 3.6             | V     |   |  |  |  |
|                   |   | 3    |                    | $V_{CC}$        | V     | No Load   |  |  |  |
| V <sub>OD</sub>   | Differential Driver Output                          | 2    |                    | V <sub>CC</sub> | V     | $R_L = 100\Omega$ (RS-422), Figure 3  |  |  |  |
| VOD               | Differential Driver Output                          | 1.65 |                    | V <sub>CC</sub> | V     | $R_L = 54\Omega$ (RS-485), Figure 3   |  |  |  |
|                   |   | 1.5  |                    | V <sub>CC</sub> | V     | -7V ≤ V <sub>CM</sub> ≤ +12V, Figure 4  |  |  |  |
| ΔV <sub>OD</sub>  | Change in Magnitude of Differential Output Voltage  |      |                    | ±0.2            | V     | D 4000 (D0 400)   |  |  |  |
| V <sub>CM</sub>   | Driver Common-Mode Output<br>Voltage (steady state) |      | V <sub>CC</sub> /2 | 3               | V     | $R_L = 100\Omega$ (RS-422), or<br>$R_L = 54\Omega$ (RS-485),<br>Figure 3, Note 1  |  |  |  |
| ΔV <sub>CM</sub>  | Change in Magnitude of Common-Mode Output Voltage   |      |                    | ±0.2            | V     | ,   |  |  |  |
| V <sub>IH</sub>   | Logic Input Thresholds (DI, DE, RE)                 | 2.0  |                    |                 | V     | Logic Input High  |  |  |  |
| $V_{IL}$          | = Logic input Triconolus (Di, DE, TiE)              |      |                    | 0.8             | V     | Logic Input Low   |  |  |  |
| $V_{HYS}$         | Input Hysteresis (DI, DE, RE)                       |      | 100                |                 | mV    |   |  |  |  |
| I <sub>IN</sub>   | Logic Input Current (DI, DE, RE)                    |      |                    | ±1              | μΑ    | $\begin{aligned} &\text{OV} \leq \text{V}_{\text{IN}} \leq \text{V}_{\text{CC}}, \\ &\text{After first transition, Note 2} \end{aligned}$ |  |  |  |
|                   | Logic Input Current (DE and RE)                     |      | 100                | ±200            | μΑ    | Until first transition, Note 2  |  |  |  |
| I <sub>А, В</sub> | Input Current (A and B)                             |      |                    | 125             | μΑ    | $V_{OUT} = +12V, DE = 0V,$<br>$V_{CC} = 0V \text{ or } 5.5V$  |  |  |  |
| 'А, В             | input Guiterit (A and B)                            | -100 |                    |                 | μΑ    | V <sub>OUT</sub> = -7V, DE = 0V,<br>V <sub>CC</sub> = 0V or 5.5V  |  |  |  |
| l <sub>OL</sub>   | Output Leakage (Y and Z)                            |      |                    | 125             | μΑ    | $V_{OUT} = +12V, DE = 0V,$<br>$V_{CC} = 0V \text{ or } 5.5V$  |  |  |  |
| ·OL               | Full Duplex (Note 2)                                | -100 |                    |                 | μΑ    | V <sub>OUT</sub> = -7V, DE = 0V,<br>V <sub>CC</sub> = 0V or 5.5V  |  |  |  |
| I <sub>OSD</sub>  | Driver Short-Circuit Output Current                 |      |                    | ±250            | mA    | $-7V \le V_{OUT} \le +12V$ , Figure 5   |  |  |  |
| DRIVER THE        | RMAL CHARACTERISTICS                                |      | •                  |                 | •     |   |  |  |  |
| T <sub>TS</sub>   | Thermal Shutdown Temperature                        |      | 175                |                 | °C    | Junction temperature, Note 4  |  |  |  |
| T <sub>TSH</sub>  | Thermal Shutdown Hysteresis                         |      | 15                 |                 | °C    | Note 4  |  |  |  |

# XR3070-78X



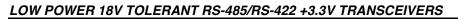


REV. 1.0.0

| SYMBOL                      | PARAMETERS  | Min.                 | TYP.  | Max. | Units | Conditions   |  |  |
|-----------------------------|---|----------------------|-------|------|-------|--|--|--|
| RECEIVER DC CHARACTERISTICS |   |                      |       |      |       |  |  |  |
| V <sub>TH</sub>             | Receiver Differential Threshold<br>Voltage (V <sub>A</sub> - V <sub>B</sub> ) | -200                 | -125  | -50  | mV    | -7V ≤ V <sub>CM</sub> ≤ +12V   |  |  |
| ΔV <sub>OH</sub>            | Receiver Input Hysteresis   |                      | 25    |      | mV    | V <sub>CM</sub> = 0V   |  |  |
| V <sub>OH</sub>             | Receiver Output High Voltage (RO)   | V <sub>CC</sub> -0.6 |       |      | V     | I <sub>OUT</sub> = -1mA  |  |  |
| V <sub>OL</sub>             | Receiver Output Low Voltage (RO)  |                      |       | 0.4  | V     | I <sub>OUT</sub> = 1mA   |  |  |
| I <sub>OZR</sub>            | High-Z Receiver Output Current  |                      |       | ±1   | μΑ    | $0V \le V_{OUT} \le V_{CC}$  |  |  |
| R <sub>IN</sub>             | Receiver Input Resistance   | 96                   |       |      | kΩ    | $-7V \le V_{CM} \le +12V$  |  |  |
| l <sub>osc</sub>            | Receiver Output Short-Circuit<br>Current                                      |                      |       | ±80  | mA    | $0V \le V_{RO} \le V_{CC}$   |  |  |
| SUPPLY CUF                  | RRENT   |                      |       |      |       |  |  |  |
|                             |   |                      | 425   | 600  | μΑ    | No Load, $\overline{RE}$ = 0V, DE = V <sub>CC</sub><br>DI = 0V         |  |  |
| I <sub>CC</sub>             | Supply Current  |                      | 330   | 600  | μΑ    | No Load, $\overline{RE} = V_{CC}$ , $DE = V_{CC}$<br>DI = 0V           |  |  |
|                             |   |                      | 300   | 500  | μΑ    | No Load, $\overline{RE}$ = 0V, DE = 0V<br>Receiver A and B inputs open |  |  |
| I <sub>SHDN</sub>           | Supply Current in Shutdown Mode   |                      | 0.001 | 1    | μΑ    | $\overline{\text{RE}} = V_{\text{CC}}, \text{ DE} = 0V$                |  |  |
| ESD PROTEG                  | ESD PROTECTION  |                      |       |      |       |  |  |  |
|                             |   |                      | ±15   |      | kV    | Human Body Model   |  |  |
|                             | ESD Protection for A, B, Y, and Z   |                      | ±15   |      | kV    | IEC 61000-4-2 Airgap   |  |  |
|                             |   |                      | ±8    |      | kV    | IEC 61000-4-2 Contact  |  |  |
|                             | ESD Protection for all other pins   |                      | ±4    |      | kV    | Human Body Model   |  |  |

# LOW POWER 18V TOLERANT RS-485/RS-422 +3.3V TRANSCEIVERS

| SYMBOL                                  | PARAMETERS  | Min. | TYP. | Max. | Units   | Conditions                                    |  |  |
|---|---|------|------|------|---------|---|--|--|
| DRIVER AC C                             | DRIVER AC CHARACTERISTICS XR3070X, XR3071X and XR3072X (250kbps |      |      |      |         |   |  |  |
| t <sub>DPLH</sub>                       | Driver Prop. Delay (Low to High)                                | 250  |      | 1500 | ns      |   |  |  |
| t <sub>DPHL</sub>                       | Driver Prop. Delay (High to Low)                                | 250  |      | 1500 | ns      | $C_{l} = 50 \text{pF}, R_{l} = 54 \Omega,$    |  |  |
| It <sub>DPLH</sub> -t <sub>DPHL</sub> I | Differential Driver Output Skew                                 |      | 20   | 200  | ns      | Figure 6                                      |  |  |
| t <sub>DR</sub> , t <sub>DF</sub>       | Driver Differential Output<br>Rise or Fall Time                 | 350  |      | 1600 | ns      |   |  |  |
|   | Maximum Data Rate   | 250  |      |      | kbps    | 1/t <sub>UI</sub> , Duty Cycle 40 to 60%      |  |  |
| t <sub>DZH</sub>                        | Driver Enable to Output High                                    |      | 200  | 2500 | ns      |   |  |  |
| t <sub>DZL</sub>                        | Driver Enable to Output Low                                     |      | 200  | 2500 | ns      | $C_L = 50pF, R_L = 500\Omega,$                |  |  |
| t <sub>DHZ</sub>                        | Driver Disable from Output High                                 |      | 6    | 100  | ns      | Figure 7                                      |  |  |
| t <sub>DLZ</sub>                        | Driver Disable from Output Low                                  |      | 6    | 100  | ns      |   |  |  |
| t <sub>DZH(SHDN)</sub>                  | Driver Enable from Shutdown to<br>Output High                   |      |      | 5500 | ns      | $C_L = 50pF, R_L = 500\Omega,$<br>Figure 7    |  |  |
| t <sub>DZL(SHDN)</sub>                  | Driver Enable from Shutdown to<br>Output Low                    |      |      | 5500 | ns      |   |  |  |
| t <sub>SHDN</sub>                       | Time to Shutdown  | 50   | 200  | 600  | ns      | Notes 3 and 4                                 |  |  |
| RECEIVER AG                             | C CHARACTERISTICS   |      |      | XR30 | 70X, XF | 3071X and XR3072X (250kbps)                   |  |  |
| t <sub>RPLH</sub>                       | Receiver Prop. Delay (Low to High)                              |      |      | 200  | ns      | C <sub>L</sub> = 15pF, V <sub>ID</sub> = ±2V, |  |  |
| t <sub>RPHL</sub>                       | Receiver Prop. Delay (High to Low)                              |      |      | 200  | ns      | V <sub>ID</sub> Rise and Fall times < 15ns    |  |  |
| It <sub>RPLH</sub> -t <sub>RPHL</sub> I | Receiver Propagation Delay Skew                                 |      |      | 30   | ns      | Figure 8                                      |  |  |
|   | Maximum Data Rate   | 250  |      |      | kbps    | 1/t <sub>UI</sub> , Duty Cycle 40 to 60%      |  |  |
| t <sub>RZH</sub>                        | Receiver Enable to Output High                                  |      |      | 50   | ns      |   |  |  |
| t <sub>RZL</sub>                        | Receiver Enable to Output Low                                   |      |      | 50   | ns      | $C_L = 15pF, R_L = 1k\Omega,$ Figure 9        |  |  |
| t <sub>RHZ</sub>                        | Receiver Disable from Output High                               |      |      | 50   | ns      |   |  |  |
| t <sub>RLZ</sub>                        | Receiver Disable from Output Low                                |      |      | 50   | ns      |   |  |  |
| t <sub>RZH(SHDN)</sub>                  | Receiver Enable from Shutdown to Output High                    |      |      | 3500 | ns      | $C_L = 15pF, R_L = 1k\Omega,$                 |  |  |
| t <sub>RZL(SHDN)</sub>                  | Receiver Enable from Shutdown to Output Low                     |      |      | 3500 | ns      | Figure 9                                      |  |  |
| t <sub>SHDN</sub>                       | Time to Shutdown  | 50   | 200  | 600  | ns      | Notes 3 and 4                                 |  |  |





| SYMBOL                                  | PARAMETERS   | Min. | TYP. | Max. | Units            | Conditions                                    |  |  |
|---|--|------|------|------|------------------|---|--|--|
| DRIVER AC C                             | DRIVER AC CHARACTERISTICS XR3073X, XR3074X and XR3075X (1Mbps) |      |      |      |                  |   |  |  |
| t <sub>DPLH</sub>                       | Driver Prop. Delay (Low to High)                               |      | 150  | 300  | ns               |   |  |  |
| t <sub>DPHL</sub>                       | Driver Prop. Delay (High to Low)                               |      | 150  | 300  | ns               | $C_1 = 50 \text{pF}, R_1 = 54 \Omega,$        |  |  |
| It <sub>DPLH</sub> -t <sub>DPHL</sub> I | Differential Driver Output Skew                                |      | 5    | 50   | ns               | Figure 6                                      |  |  |
| t <sub>DR</sub> , t <sub>DF</sub>       | Driver Differential Output<br>Rise or Fall Time                | 100  | 200  | 300  | ns               |   |  |  |
|   | Maximum Data Rate  | 1    |      |      | Mbps             | 1/t <sub>UI</sub> , Duty Cycle 40 to 60%      |  |  |
| t <sub>DZH</sub>                        | Driver Enable to Output High                                   |      | 1000 | 2500 | ns               |   |  |  |
| t <sub>DZL</sub>                        | Driver Enable to Output Low                                    |      | 1000 | 2500 | ns               | $C_L = 50pF, R_L = 500\Omega,$                |  |  |
| t <sub>DHZ</sub>                        | Driver Disable from Output High                                |      | 60   | 100  | ns               | Figure 7                                      |  |  |
| t <sub>DLZ</sub>                        | Driver Disable from Output Low                                 |      | 60   | 100  | ns               |   |  |  |
| t <sub>DZH(SHDN)</sub>                  | Driver Enable from Shutdown to<br>Output High                  |      |      | 3500 | ns               | $C_L = 50$ pF, $R_L = 500\Omega$ ,            |  |  |
| t <sub>DZL(SHDN)</sub>                  | Driver Enable from Shutdown to<br>Output Low                   |      |      | 3500 | ns               | Figure 7                                      |  |  |
| t <sub>SHDN</sub>                       | Time to Shutdown   | 50   | 200  | 600  | ns               | Notes 3 and 4                                 |  |  |
| RECEIVER AC                             | C CHARACTERISTICS  |      |      | XR   | <b>3073X</b> , 2 | XR3074X and XR3075X (1Mbps)                   |  |  |
| t <sub>RPLH</sub>                       | Receiver Prop. Delay (Low to High)                             |      |      | 200  | ns               | C <sub>L</sub> = 15pF, V <sub>ID</sub> = ±2V, |  |  |
| t <sub>RPHL</sub>                       | Receiver Prop. Delay (High to Low)                             |      |      | 200  | ns               | V <sub>ID</sub> Rise and Fall times < 15ns    |  |  |
| It <sub>RPLH</sub> -t <sub>RPHL</sub> I | Receiver Propagation Delay Skew                                |      |      | 30   | ns               | Figure 8                                      |  |  |
|   | Maximum Data Rate  | 1    |      |      | Mbps             | 1/t <sub>UI</sub> , Duty Cycle 40 to 60%      |  |  |
| t <sub>RZH</sub>                        | Receiver Enable to Output High                                 |      |      | 50   | ns               |   |  |  |
| t <sub>RZL</sub>                        | Receiver Enable to Output Low                                  |      |      | 50   | ns               | $C_L = 15pF, R_L = 1k\Omega,$                 |  |  |
| t <sub>RHZ</sub>                        | Receiver Disable from Output High                              |      |      | 50   | ns               | Figure 9                                      |  |  |
| t <sub>RLZ</sub>                        | Receiver Disable from Output Low                               |      |      | 50   | ns               |   |  |  |
| t <sub>RZH(SHDN)</sub>                  | Receiver Enable from Shutdown to Output High                   |      |      | 3500 | ns               | $C_L = 15pF, R_L = 1k\Omega,$                 |  |  |
| t <sub>RZL(SHDN)</sub>                  | Receiver Enable from Shutdown to Output Low                    |      |      | 3500 | ns               | Figure 9                                      |  |  |
| t <sub>SHDN</sub>                       | Time to Shutdown   | 50   | 200  | 600  | ns               | Notes 3 and 4                                 |  |  |



| SYMBOL                                  | PARAMETERS  | Min. | TYP. | Max. | Units   | CONDITIONS                                    |  |  |
|---|---|------|------|------|---------|---|--|--|
| DRIVER AC C                             | DRIVER AC CHARACTERISTICS XR3076X, XR3077X and XR3078X (20Mbps) |      |      |      |         |   |  |  |
| t <sub>DPLH</sub>                       | Driver Prop. Delay (Low to High)                                |      |      | 25   | ns      |   |  |  |
| t <sub>DPHL</sub>                       | Driver Prop. Delay (High to Low)                                |      |      | 25   | ns      | $C_1 = 50 pF, R_1 = 54 \Omega,$               |  |  |
| It <sub>DPLH</sub> -t <sub>DPHL</sub> I | Differential Driver Output Skew                                 |      |      | 5    | ns      | Figure 6                                      |  |  |
| t <sub>DR</sub> , t <sub>DF</sub>       | Driver Differential Output<br>Rise or Fall Time                 |      | 15   |      | ns      |   |  |  |
|   | Maximum Data Rate   | 20   |      |      | Mbps    | 1/t <sub>UI</sub> , Duty Cycle 40 to 60%      |  |  |
| t <sub>DZH</sub>                        | Driver Enable to Output High                                    |      |      | 45   | ns      |   |  |  |
| t <sub>DZL</sub>                        | Driver Enable to Output Low                                     |      |      | 45   | ns      | $C_L = 50pF, R_L = 500\Omega,$                |  |  |
| t <sub>DHZ</sub>                        | Driver Disable from Output High                                 |      |      | 40   | ns      | Figure 7                                      |  |  |
| t <sub>DLZ</sub>                        | Driver Disable from Output Low                                  |      |      | 40   | ns      |   |  |  |
| t <sub>DZH(SHDN)</sub>                  | Driver Enable from Shutdown to Output High                      |      |      | 250  | ns      | $C_L$ = 50pF, $R_L$ = 500 $\Omega$ , Figure 7 |  |  |
| t <sub>DZL(SHDN)</sub>                  | Driver Enable from Shutdown to Output Low                       |      |      | 250  | ns      |   |  |  |
| t <sub>SHDN</sub>                       | Time to Shutdown  | 50   | 200  | 600  | ns      | Notes 3 and 4                                 |  |  |
| RECEIVER A                              | C CHARACTERISTICS   |      |      | XR3  | 076X, X | R3077X and XR3078X (20Mbps)                   |  |  |
| t <sub>RPLH</sub>                       | Receiver Prop. Delay (Low to High)                              |      |      | 50   | ns      | $C_{I} = 15pF, V_{ID} = \pm 2V,$              |  |  |
| t <sub>RPHL</sub>                       | Receiver Prop. Delay (High to Low)                              |      |      | 50   | ns      | V <sub>ID</sub> Rise and Fall times < 15ns    |  |  |
| It <sub>RPLH</sub> -t <sub>RPHL</sub> I | Receiver Propagation Delay Skew                                 |      |      | 5    | ns      | Figure 8                                      |  |  |
|   | Maximum Data Rate   | 20   |      |      | Mbps    | 1/t <sub>UI</sub> , Duty Cycle 40 to 60%      |  |  |
| t <sub>RZH</sub>                        | Receiver Enable to Output High                                  |      |      | 30   | ns      |   |  |  |
| t <sub>RZL</sub>                        | Receiver Enable to Output Low                                   |      |      | 30   | ns      | $C_L = 15pF, R_L = 1k\Omega,$                 |  |  |
| t <sub>RHZ</sub>                        | Receiver Disable from Output High                               |      |      | 30   | ns      | Figure 9                                      |  |  |
| t <sub>RLZ</sub>                        | Receiver Disable from Output Low                                |      |      | 30   | ns      |   |  |  |
| t <sub>RZH(SHDN)</sub>                  | Receiver Enable from Shutdown to Output High                    |      |      | 1800 | ns      | $C_L = 15pF, R_L = 1k\Omega,$                 |  |  |
| t <sub>RZL(SHDN)</sub>                  | Receiver Enable from Shutdown to Output Low                     |      |      | 1800 | ns      | Figure 9                                      |  |  |
| t <sub>SHDN</sub>                       | Time to Shutdown  | 50   | 200  | 600  | ns      | Notes 3 and 4                                 |  |  |

#### XR3070-78X

# LOW POWER 18V TOLERANT RS-485/RS-422 +3.3V TRANSCEIVERS



REV. 1.0.0

#### Note:

- 1. Change in Magnitude of Differential Output Voltage and Change in Magnitude of Common Mode Output Voltage are the changes in output voltage when DI input changes state.
- 2. The hot swap feature disables the DE and  $\overline{RE}$  inputs for the first 10 $\mu$ s after power is applied. Following this time period these inputs are weakly pulled to their disabled state (low for DE, high for  $\overline{RE}$ ) until the first transition, after which they become high impedance inputs.
- 3. The transceivers are put into shutdown by bringing  $\overline{RE}$  High and DE Low simultaneously for at least 600ns. If the control inputs are in this state for less than 50ns, the device is guaranteed to not enter shutdown. If the enable inputs are held in this state for at least 600ns the device is assured to be in shutdown. Note that the receiver and driver enable times increase significantly when coming out of shutdown.
- 4. This spec is guaranteed by design and bench characterization.



# **BLOCK DIAGRAMS**

FIGURE 1. HALF DUPLEX (XR3072X, XR3075X, XR3078X)

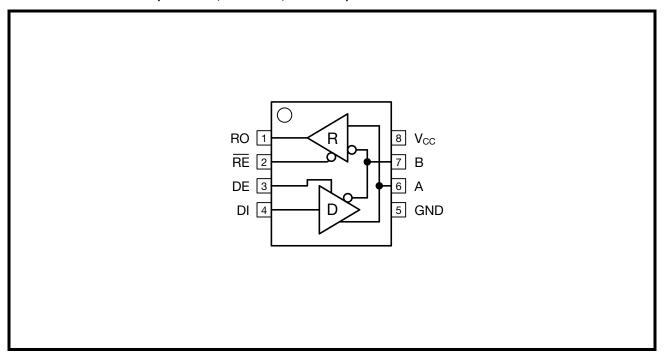
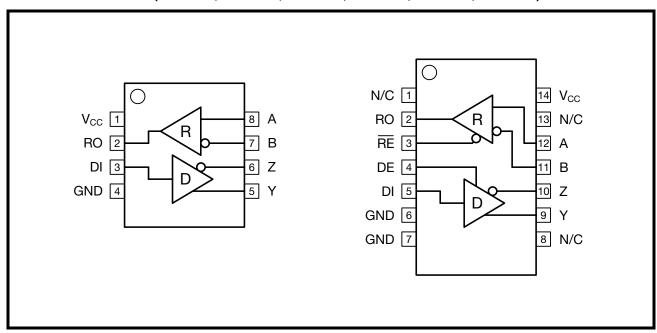


FIGURE 2. FULL DUPLEX (XR3070X, XR3071X, XR3073X, XR3074X, XR3076X, XR3077X)





## **TEST FIGURES**

#### FIGURE 3. DIFFERENTIAL DRIVER OUTPUT VOLTAGE

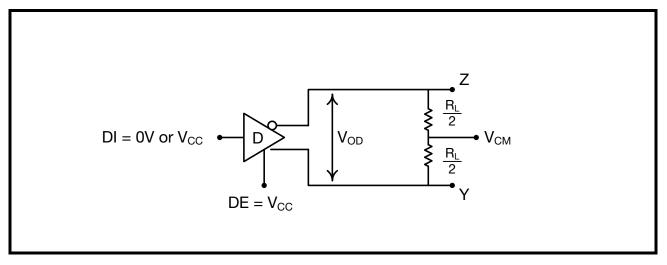


FIGURE 4. DIFFERENTIAL DRIVER OUTPUT VOLTAGE OVER COMMON MODE

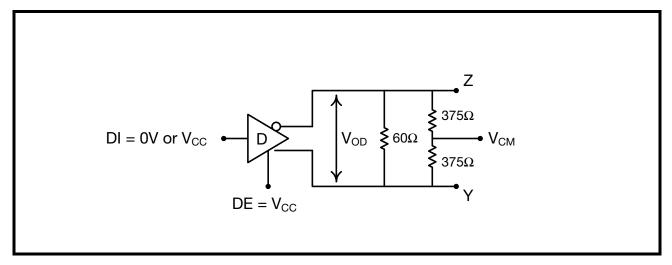


FIGURE 5. DRIVER OUTPUT SHORT CIRCUIT CURRENT

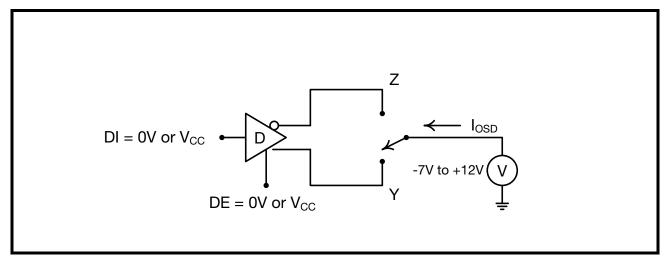
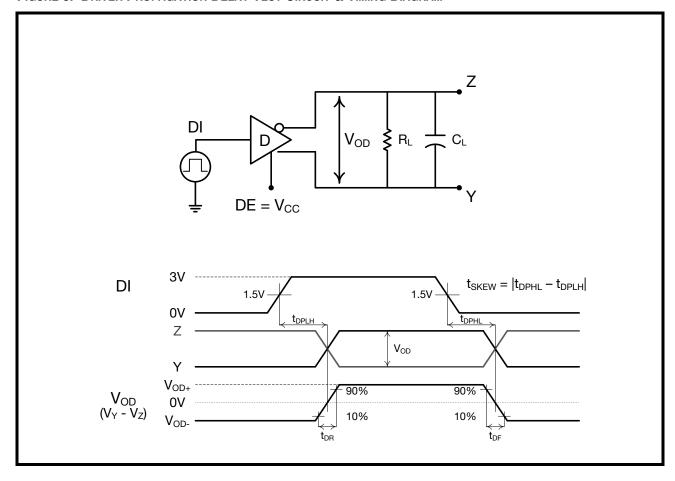




FIGURE 6. DRIVER PROPAGATION DELAY TEST CIRCUIT & TIMING DIAGRAM





#### FIGURE 7. DRIVER ENABLE AND DISABLE TIMING TEST CIRCUITS & TIMING DIAGRAMS

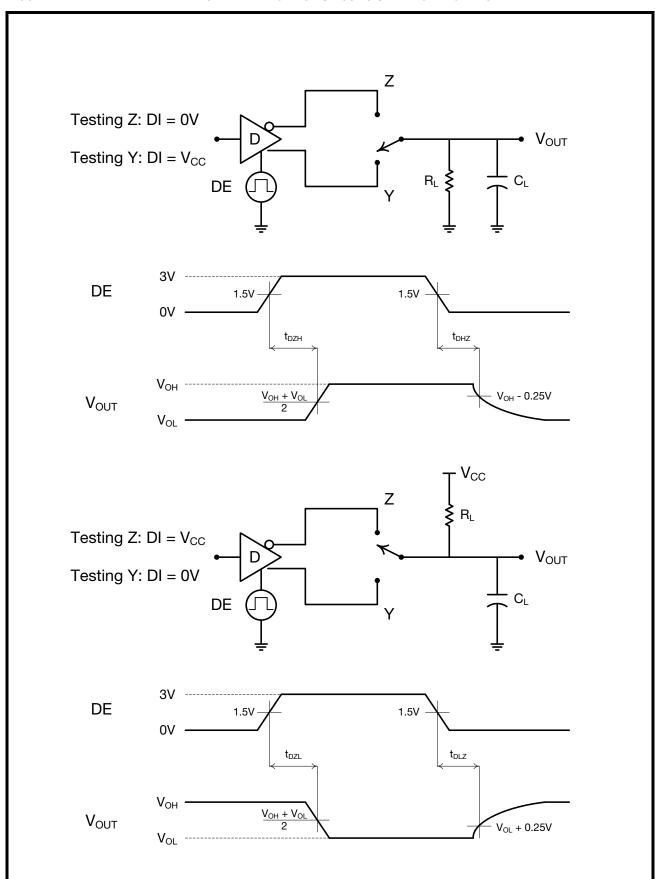




FIGURE 8. RECEIVER PROPAGATION DELAY TEST CIRCUIT & TIMING DIAGRAM

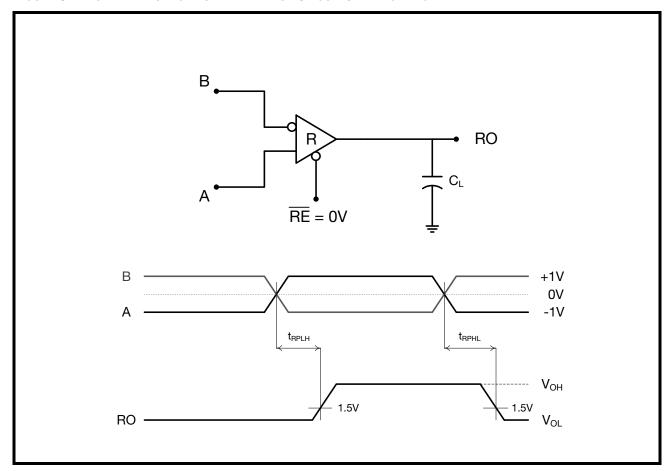
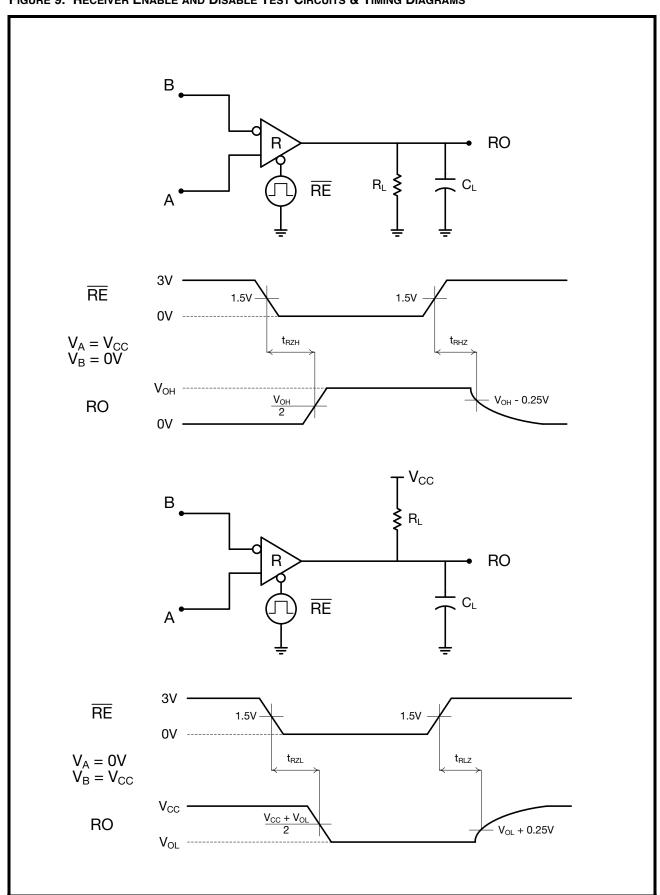




FIGURE 9. RECEIVER ENABLE AND DISABLE TEST CIRCUITS & TIMING DIAGRAMS





# **PIN DESCRIPTIONS**

|                               | PIN NUMBER                    |                               |                 |      |  |  |  |
|-------------------------------|-------------------------------|-------------------------------|-----------------|------|--|--|--|
| HALF DUPLEX                   | FULL D                        | UPLEX                         |                 |      | _  |  |  |
| XR3072X<br>XR3075X<br>XR3078X | XR3071X<br>XR3074X<br>XR3077X | XR3070X<br>XR3073X<br>XR3076X | PIN NAME        | Түре | DESCRIPTION  |  |  |
| 1                             | 2                             | 2                             | RO              | Out  | Receiver Output. When $\overline{\text{RE}}$ is low and if (A-B) $\leq$ -50mV, RO is high. If (A-B) $\geq$ -200mV, RO is Low.  |  |  |
| 2                             | -                             | 3                             | RE              | In   | Receiver Output Enable (Hot Swap). When $\overline{RE}$ is low, RO is enabled. When $\overline{RE}$ is High, RO is high impedance. $\overline{RE}$ should be high and DE should be low to enter shutdown mode. |  |  |
| 3                             | -                             | 4                             | DE              | In   | Driver Output Enable (Hot Swap).  When DE is high, outputs are enabled. When DE is low, outputs are high impedance. DE should be low and RE should be high to enter shutdown mode.                             |  |  |
| 4                             | 3                             | 5                             | DI              | In   | Driver Input.  With DE high, a low level on DI forces non-Inverting output low and inverting output high. Similarly, a high level on DI forces non-Inverting output high and inverting output low.             |  |  |
| 5                             | 4                             | 6, 7                          | GND             | Pwr  | Ground.  |  |  |
| 6                             | -                             | -                             | А               | I/O  | Non-Inverting Receiver Input and<br>Non-Inverting Driver Output.   |  |  |
| 7                             | -                             | -                             | В               | I/O  | Inverting Receiver Input and Inverting Driver Output.  |  |  |
| 8                             | 1                             | 14                            | V <sub>CC</sub> | Pwr  | +3.3V Power Supply Input. Bypass to ground with 0.1 $\mu$ F capacitor.   |  |  |
| -                             | 8                             | 12                            | Α               | ln   | Non-Inverting Receiver Input.  |  |  |
| -                             | 7                             | 11                            | В               | ln   | Inverting Reciever Input.  |  |  |
| -                             | 5                             | 9                             | Y               | Out  | Non-Inverting Driver Output.   |  |  |
| -                             | 6                             | 10                            | Z               | Out  | Inverting Driver Output.   |  |  |
| -                             | -                             | 1, 8, 13                      | N/C             | -    | No Connect, not internally connected.  |  |  |

## PRODUCT DESCRIPTION

The XR3070-78X RS-485/422 devices are part of Exar's X Series high performance serial interface product line. The analog bus pins can survive direct shorts up to ±18V, and are protected against ESD events up to ±15kV. The high output differential driver delivers 10% higher SNR than other RS-485/422 devices, affording additional noise margin or extended cable lengths.

#### **ENHANCED FAILSAFE**

Ordinary RS-485 differential receivers will be in an indeterminate state whenever the data bus is not being actively driven. The enhanced failsafe feature of the XR3070-78X family guarantees a logic-high receiver output when the receiver inputs are open, shorted, or when they are connected to a terminated transmission line with all drivers disabled. In a terminated bus with all transmitters disabled, the receivers' differential input voltage is pulled to 0V by the termination. The XR3070-78X family interprets 0V differential as a logic high with a minimum 50mV noise margin while maintaining compliance with the EIA/TIA-485 standard of ±200mV. Although the XR3070-78X family does not need failsafe biasing resistors, it can operate without issue if biasing is used.

#### RECEIVER INPUT FILTERING

XR3070-75X receivers incorporate internal filtering in addition to input hysteresis. This filtering enhances noise immunity by ignoring signals that do not meet a minimum pulse width of 30ns. Receiver propagation delay increases slightly due to this filtering. The high speed XR3076X, XR3077X and XR3078X devices do not have this input filtering.

#### **HOT-SWAP CAPABILITY**

When  $V_{CC}$  is first applied the XR3070-78X devices with DE and  $\overline{RE}$  pins (70, 72, 73, 75, 76, & 78) hold the driver enable and receiver enable inactive for approximately 10 microseconds. During power ramp-up other system ICs may drive unpredictable values, or tristated lines may be influenced by stray capacitance. The hotswap feature prevents these devices from driving any output signal until power has stabilized. After the initial  $10\mu$ s, the driver and receiver enable pins are weakly pulled to their disabled states (low for DE, high for  $\overline{RE}$ ) until the first transition. After the first transition, the DE and  $\overline{RE}$  pins operate as high impedance inputs.

If circuit boards are inserted into an energized backplane (commonly called "live insertion" or "hot-swap") power may suddenly be applied to all circuits. Without the hot-swap capability, this situation could improperly enable the transceiver's driver or receiver, driving invalid data onto shared busses and possibly causing driver contention or device damage.

#### **DRIVER OUTPUT PROTECTION**

Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. First, a driver current limit on the output stage provides immediate protection against short circuits over the whole common-mode voltage range. Second, a thermal-shutdown circuit forces the driver outputs into a high-impedance state if junction temperature becomes excessive.

#### **LINE LENGTH**

The RS-485/RS-422 standard covers line lengths up to 4000ft. Maximum achievable line length is a function of signal attenuation and noise. Termination prevents signal reflections by eliminating the impedance mismatches on a transmission line. Line termination is generally used if rise and fall times are shorter than the round-trip signal propagation time. Higher output drivers may allow longer cables to be used.



#### ±15kV ESD PROTECTION

ESD protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The driver outputs and receiver inputs of the XR3070-78X family have extra protection against static electricity. Exar uses state of the art structures to protect these pins against ESD of ±15kV without damage. The ESD structures withstand high ESD in all states; normal operation, shutdown and powered down. After an ESD event, the XR3070-78X keep operating without latch-up or damage.

ESD protection can be tested in various ways. The transmitter outputs and receiver inputs of the XR3070-78X are characterized for protection to the following limits:

- ±15kV using the Human Body Model
- ±8kV Contact Discharge Model
- ±15kV Air-gap Discharge Model

#### **ESD TEST CONDITIONS**

ESD performance depends on a variety of conditions. Contact Exar for a reliability report that documents test setup, methodology and results.

#### IEC 61000-4-2

The IEC 61000-4-2 standard covers ESD testing and performance of finished equipment. However, it does not specifically refer to integrated circuits. The XR3070-78X family helps you design equipment to meet IEC 61000-4-2, without sacrificing board-space and cost for external ESD-protection components.

The major differences between tests done using the Human body model and IEC 61000-4-2 is a higher peak current in IEC 61000-4-2. Series resistance is lower in the IEC 61000-4-2 model. Hence, the ESD withstand voltage measured to IEC 61000-4-2 is generally lower than that of human body model.

The air-gap test involves approaching the device with a charged probe. The contact discharge method connects the probe to the device before the probe is energized.

#### 256 TRANSCEIVERS ON THE BUS

The standard RS-485 receiver input impedance is 12k Ohms (1 unit load). A standard driver can drive up to 32 unit loads. The XR3070-78X family of transceivers have a 1/8<sup>th</sup> unit load receiver input impedance of 96kΩ. allowing up to 256 transceivers to be connected in parallel on a communication line. Any combination of these devices and other RS-485 transceivers up to a total of 32 unit loads may be connected to the line.

#### **LOW POWER SHUTDOWN MODE**

Low-power shutdown mode is initiated by bringing both RE high and DE low simultaneously. While in shutdown devices draw less than  $1\mu A$  of supply current. DE and  $\overline{RE}$  may be tied together and driven by a single control signal. Devices are guaranteed not to enter shutdown if RE is high and DE is low for less than 50ns. If the inputs are in this state for at least 600ns, the parts will enter shutdown.

Enable times t<sub>ZH</sub> and t<sub>ZL</sub> apply when the part is not in low-power shutdown state. Enable times t<sub>ZH(SHDN)</sub> and t<sub>71 (SHDN)</sub> apply when the parts are shutdown. The drivers and receivers take longer to become enabled from low-power shutdown  $t_{ZH(SHDN)}$  and  $t_{ZL(SHDN)}$  than from driver / receiver disable mode ( $t_{ZH}$  and  $t_{ZL}$ ).



# **FUNCTION TABLES**

TABLE 1: FULL DUPLEX 14 PIN - XR3070X, XR3073X AND XR3076X

| TRANSMITTING |        |    |          |   |  |  |
|--------------|--------|----|----------|---|--|--|
|              | Inputs |    | Outputs  |   |  |  |
| RE           | DE     | DI | Y        | Z |  |  |
| Х            | 1      | 1  | 1        | 0 |  |  |
| Х            | 1      | 0  | 0        | 1 |  |  |
| 0            | 0      | Х  | High-Z   |   |  |  |
| 1            | 0      | Х  | Shutdown |   |  |  |

TABLE 2: FULL DUPLEX 8 PIN - XR3071X, XR3074X AND XR3077X

| TRANSMITTING |         |   |  |  |  |
|--------------|---------|---|--|--|--|
| Input        | Outputs |   |  |  |  |
| DI           | Y       | Z |  |  |  |
| 1            | 1       | 0 |  |  |  |
| 0            | 0       | 1 |  |  |  |

TABLE 3: HALF DUPLEX 8 PIN - XR3072X, XR3075X AND XR3078X

| TRANSMITTING |    |    |          |   |  |  |
|--------------|----|----|----------|---|--|--|
| Inputs       |    |    | Outputs  |   |  |  |
| RE           | DE | DI | А        | В |  |  |
| Х            | 1  | 1  | 1        | 0 |  |  |
| Х            | 1  | 0  | 0        | 1 |  |  |
| 0            | 0  | Х  | High-Z   |   |  |  |
| 1            | 0  | Х  | Shutdown |   |  |  |



TABLE 4: FULL DUPLEX 14 PIN - XR3070X, XR3073X AND XR3076X

| RECEIVING |        |                                 |          |  |  |
|-----------|--------|---------------------------------|----------|--|--|
|           | Inputs |                                 | Ouptut   |  |  |
| RE        | DE     | V <sub>A</sub> - V <sub>B</sub> | RO       |  |  |
| 0         | Х      | ≥ -50mV                         | 1        |  |  |
| 0         | Х      | ≤ -200mV                        | 0        |  |  |
| 0         | Х      | Open/Shorted                    | 1        |  |  |
| 1         | 1      | Х                               | High-Z   |  |  |
| 1         | 0      | Х                               | Shutdown |  |  |

TABLE 5: FULL DUPLEX 8 PIN - XR3071X, XR3074X AND XR3077X

| RECEIVING                       |        |  |  |
|---------------------------------|--------|--|--|
| Inputs                          | Output |  |  |
| V <sub>A</sub> - V <sub>B</sub> | RO     |  |  |
| ≥ -50mV                         | 1      |  |  |
| ≤ <b>-</b> 200mV                | 0      |  |  |
| Open/Shorted                    | 1      |  |  |

TABLE 6: HALF DUPLEX 8 PIN - XR3072X, XR3075X AND XR3078X

| RECEIVING |    |                                 |          |  |  |  |
|-----------|----|---------------------------------|----------|--|--|--|
| Inputs    |    |                                 | Output   |  |  |  |
| RE        | DE | V <sub>A</sub> - V <sub>B</sub> | RO       |  |  |  |
| 0         | X  | ≥ -50mV                         | 1        |  |  |  |
| 0         | X  | ≤ -200mV                        | 0        |  |  |  |
| 0         | Х  | Open/Shorted                    | 1        |  |  |  |
| 1         | 1  | X High-Z                        |          |  |  |  |
| 1         | 0  | Х                               | Shutdown |  |  |  |

Note: Receiver inputs -200mV  $\leq$  VA - VB  $\leq$  -50mV are considered indeterminate.



# PRODUCT SELECTOR GUIDE

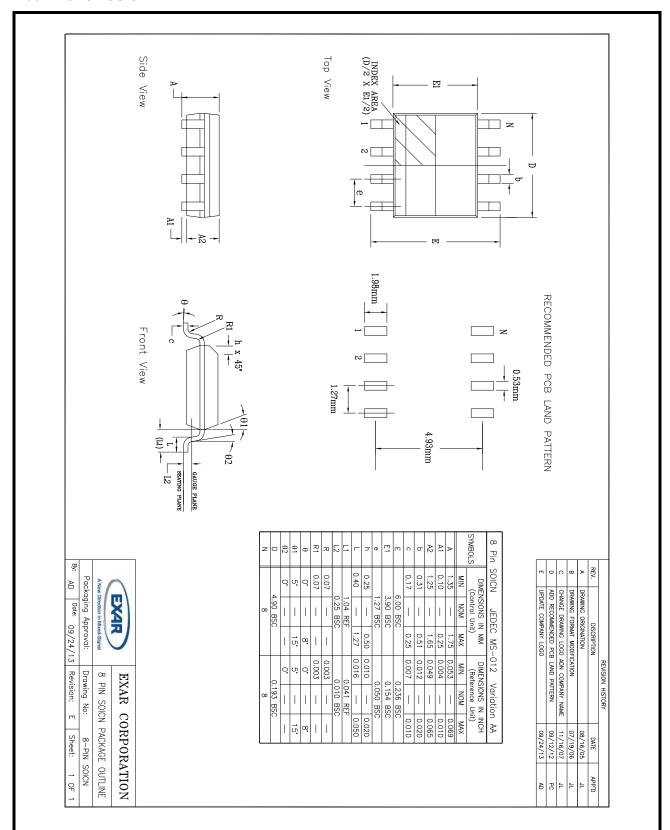
# **TABLE 7: SELECTION GUIDE**

| PART<br>NUMBER | DUPLEX | DATA RATE | SHUTDOWN | RECEIVER<br>AND DRIVER<br>ENABLE | TRANS ON<br>BUS | FOOTPRINT |
|----------------|--------|-----------|----------|----------------------------------|-----------------|-----------|
| XR3070XID-F    | Full   |           | Yes      | Yes                              | 256             | SN75180   |
| XR3071XID-F    | Full   | 250kbps   | No       | No                               | 256             | SN75179   |
| XR3072XID-F    | Half   |           | Yes      | Yes                              | 256             | SN75176   |
| XR3073XID-F    | Full   |           | Yes      | Yes                              | 256             | SN75180   |
| XR3074XID-F    | Full   | 1Mbps     | No       | No                               | 256             | SN75179   |
| XR3075XID-F    | Half   |           | Yes      | Yes                              | 256             | SN75176   |
| XR3076XID-F    | Full   |           | Yes      | Yes                              | 256             | SN75180   |
| XR3077XID-F    | Full   | 20Mbps    | No       | No                               | 256             | SN75179   |
| XR3078XID-F    | Half   |           | Yes      | Yes                              | 256             | SN75176   |



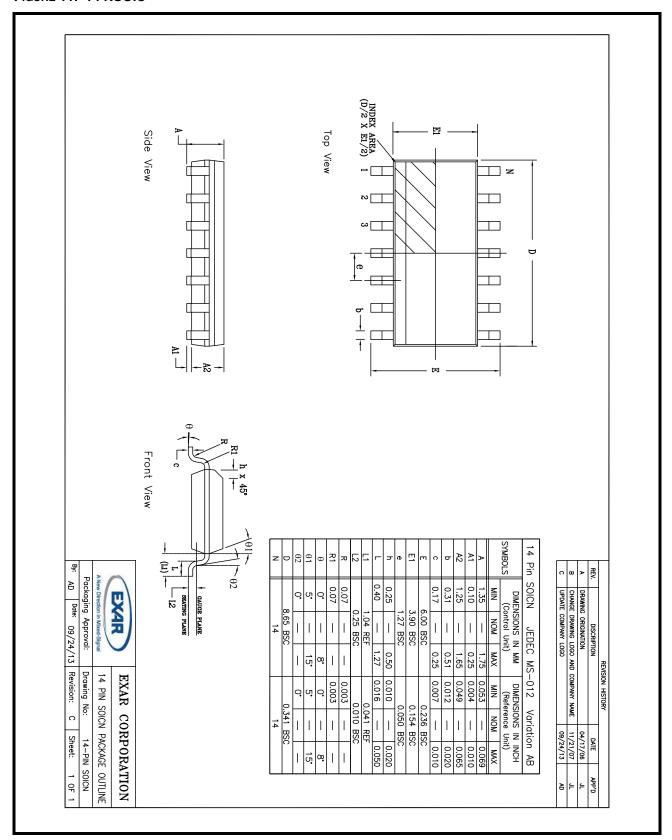
# **PACKAGE DRAWINGS**

#### FIGURE 10. 8 NSOIC





#### FIGURE 11. 14 NSOIC



#### REVISION HISTORY

| DATE      | REVISION | DESCRIPTION        |
|-----------|----------|--------------------|
| Sept 2013 | 1.0.0    | Production Release |

#### **NOTICE**

EXAR Corporation reserves the right to make changes to the products contained in this publication in order to improve design, performance or reliability. EXAR Corporation assumes no responsibility for the use of any circuits described herein, conveys no license under any patent or other right, and makes no representation that the circuits are free of patent infringement. Charts and schedules contained here in are only for illustration purposes and may vary depending upon a user's specific application. While the information in this publication has been carefully checked; no responsibility, however, is assumed for inaccuracies.

EXAR Corporation does not recommend the use of any of its products in life support applications where the failure or malfunction of the product can reasonably be expected to cause failure of the life support system or to significantly affect its safety or effectiveness. Products are not authorized for use in such applications unless EXAR Corporation receives, in writing, assurances to its satisfaction that: (a) the risk of injury or damage has been minimized; (b) the user assumes all such risks; (c) potential liability of EXAR Corporation is adequately protected under the circumstances.

Copyright 2013 EXAR Corporation

Datasheet Sept 2013.

For technical support please email Exar's Serial Technical Support group at: serialtechsupport@exar.com.

Reproduction, in part or whole, without the prior written consent of EXAR Corporation is prohibited.

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

# Exar:

<u>XR3077XID-F</u> <u>XR3076XID-F</u> <u>XR3070XID-F</u> <u>XR3074XID-F</u> <u>XR3078XID-F</u> <u>XR3072XID-F</u> <u>XR3075XID-F</u> <u>XR3071XID-F</u> <u>XR3073XID-F</u> <u>XR3071XIDTR-F</u> <u>XR3072XIDTR-F</u> <u>XR3074XIDTR-F</u> <u>XR3075XIDTR-F</u> <u>XR3077XIDTR-F</u> <u>F XR3078XIDTR-F</u>